

OV N-Channel Enhancement Mode MOSFET

Description

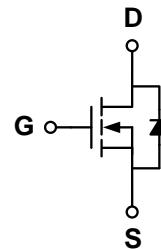
The PECN6020D6 uses advanced trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- ◆ $V_{DS} = 60V$ $I_D = 20A$
 $R_{DS(ON)}(\text{Typ.}) = 18.5m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(\text{Typ.}) = 21.5m\Omega$ @ $V_{GS} = 4.5V$
- ◆ Excellent gate charge $\times R_{DS(on)}$ product(FOM)
- ◆ Very low on-resistance $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

*100% UIS TESTED!***Application***100% ΔV_{ds} TESTED!*

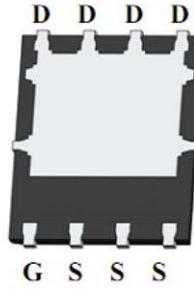
- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications

Schematic diagram**Marking and pin assignment**

PDFN5*6-8L-A



Top View



Bottom View

XXXXXX—Wafer Information

YYYYYY—Quality Code

**Ordering Information**

Part Number	Storage Temperature	Package	Devices Per Reel
PECN6020D6	-55°C to +150°C	PDFN5*6-8L-A	5000

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	60	V
Gate-source voltage	V_{GS}	± 20	V
Continuous Drain Current TC=25°C	I_D	20	A
TC=70°C		16	
Pulsed Drain Current	I_{DP}	80	A
Avalanche energy($T_j=25^\circ C$, $V_{DD}=30V$, $V_G=10V$, $L=0.5mH$, $R_g=25\Omega$)	E_{AS}	40	mJ
Power Dissipation TC=25°C	P_D	37.5	W
TC=70°C		15	
Operating junction Temperature range	T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	60	-	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =60V, V _{GS} =0V T _J =85°C	-	-	1	μA
			-	-	5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1.0	2.0	3.0	V
Drain-source on-state resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	18.5	22	mΩ
		V _{GS} =4.5V, I _D =15A	-	21.5	25	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =20A	-	55	-	S
Diode Characteristics						
Diode Forward Voltage	V _{SD}	I _{SD} =1A, V _{GS} =0V	-	0.7	1.2	V
Diode Continuous Forward Current	I _S		-	-	20	A
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S di/dt = 100A/μs	-	22	-	ns
Reverse Recovery Charge	Q _{rr}		-	76	-	nC
Dynamic Characteristics						
Gate Resistance	R _G	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	3.6	5.4	Ω
Input capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =30V f=1.0MHz	-	1582	-	pF
Output capacitance	C _{OSS}		-	100	-	
Reverse transfer capacitance	C _{RSS}		-	67	-	
Turn-on delay time	t _{D(ON)}	V _{GS} =10V, V _{DS} =30V, R _L =1.5Ω, R _G =3Ω	-	7.5	-	ns
Turn-on Rise time	tr		-	6.5	-	
Turn-off delay time	t _{D(OFF)}		-	33	-	
Turn-off Fall time	t _f		-	7.5	-	
Total gate charge	Q _g	V _{GS} =10V, V _{DS} =30V, I _D =30A	-	28	-	nC
Gate-source charge	Q _{gs}		-	4.5	-	
Gate-drain charge	Q _{gd}		3	7	-	

Thermal Characteristics

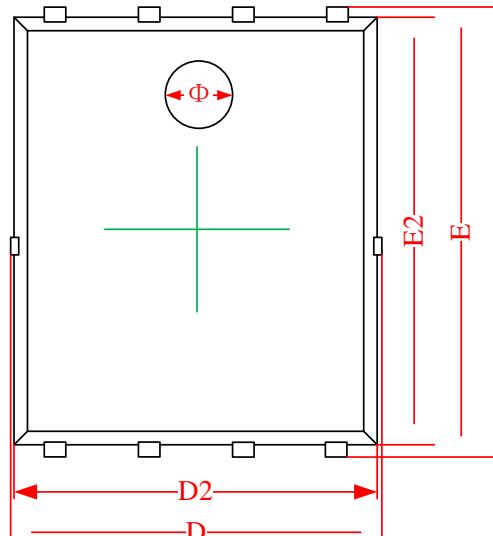
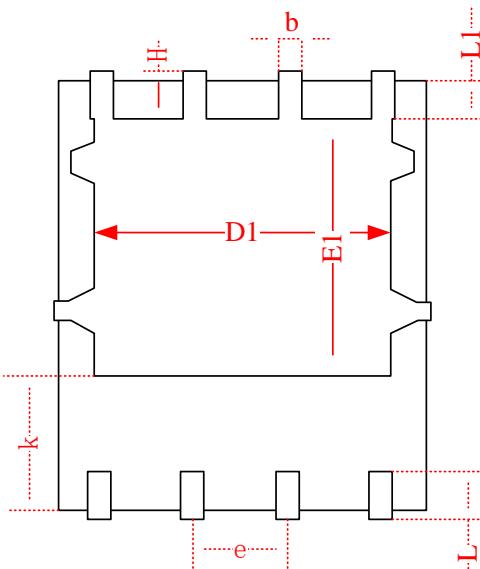
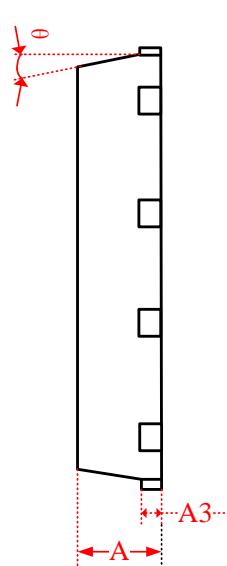
Parameter	Symbol	Typ	Max	Unit
Maximum Junction-to-Ambient ^A	R _{θJA}	12	20	°C/W
Maximum Junction-to-Ambient ^A		33	50	
Maximum Junction-to-Lead ^B		2.4	2.9	

A: The value of R_{θJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

Package Information

- PDFN5*6-8L-A

Top View**Bottom View****Side View**

SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.870	0.900	0.930	0.034	0.035	0.036
A3	0.152REF.			0.006REF.		
D	4.944	5.020	5.096	0.195	0.198	0.201
E	5.974	6.050	6.126	0.235	0.238	0.241
D1	3.910	4.010	4.110	0.154	0.158	0.162
E1	3.375	3.475	3.575	0.133	0.137	0.141
D2	4.870	4.900	4.930	0.192	0.193	0.194
E2	5.720	5.750	5.780	0.226	0.227	0.228
k	1.190	1.290	1.390	0.047	0.051	0.055
b	0.350	0.380	0.410	0.014	0.015	0.016
e	1.270TYP.			0.050TYP.		
L	0.559	0.635	0.711	0.022	0.025	0.028
L1	0.424	0.500	0.576	0.017	0.020	0.023
H	0.574	0.650	0.726	0.023	0.026	0.029
θ	10°	11°	12°	10°	11°	12°
Φ	1.150	1.200	1.250	0.045	0.047	0.049